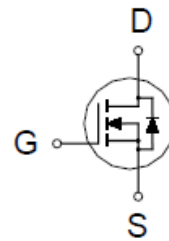
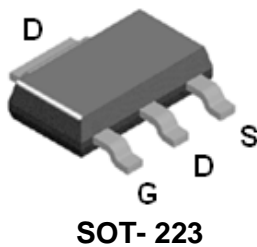


P0320AL

N-Channel Enhancement Mode MOSFET

PRODUCT SUMMARY

$V_{(BR)DSS}$	$R_{DS(ON)}$	I_D
200V	1.1 Ω @ $V_{GS} = 10V$	1A



ABSOLUTE MAXIMUM RATINGS ($T_A = 25\text{ }^\circ\text{C}$ Unless Otherwise Noted)

PARAMETERS/TEST CONDITIONS		SYMBOL	LIMITS	UNITS
Gate-Source Voltage		V_{GS}	± 30	V
Continuous Drain Current	$T_A = 25\text{ }^\circ\text{C}$	I_D	1	A
	$T_A = 70\text{ }^\circ\text{C}$		0.8	
Pulsed Drain Current ¹		I_{DM}	4	
Avalanche Current		I_{AS}	2	
Avalanche Energy	$L = 26.6\text{mH}$	E_{AS}	53	mJ
Power Dissipation	$T_A = 25\text{ }^\circ\text{C}$	P_D	2.5	W
	$T_A = 70\text{ }^\circ\text{C}$		1.6	
Operating Junction & Storage Temperature Range		T_J, T_{STG}	-55 to 150	$^\circ\text{C}$

THERMAL RESISTANCE RATINGS

THERMAL RESISTANCE	SYMBOL	TYPICAL	MAXIMUM	UNITS
Junction-to-Ambient	$R_{\theta JA}$		50	$^\circ\text{C} / \text{W}$

¹Pulse width limited by maximum junction temperature.

P0320AL

N-Channel Enhancement Mode MOSFET

ELECTRICAL CHARACTERISTICS (T_J = 25 °C, Unless Otherwise Noted)

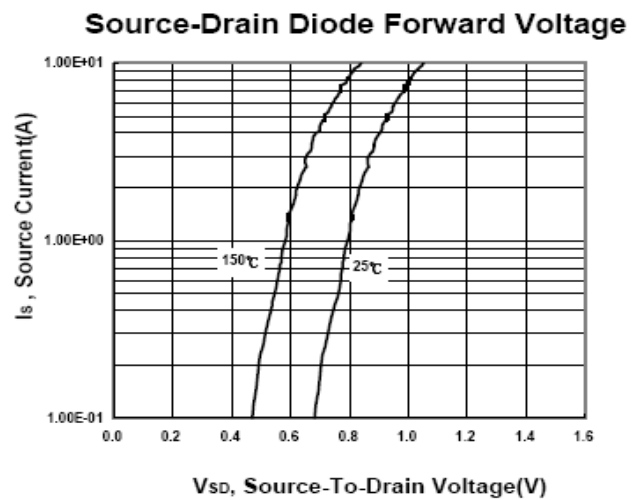
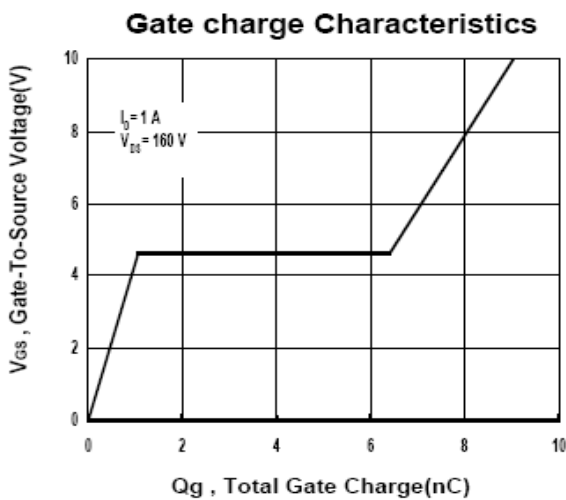
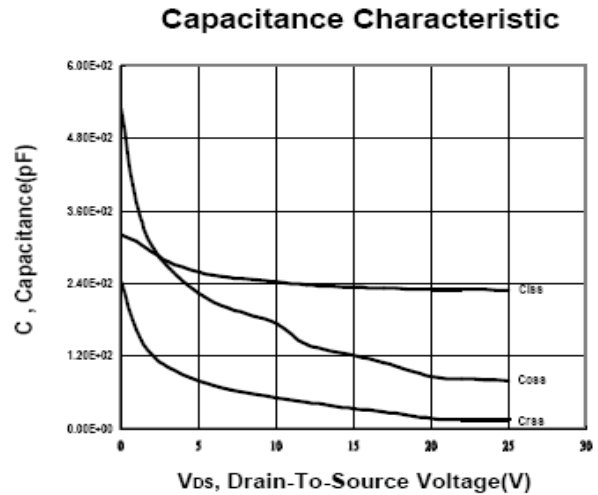
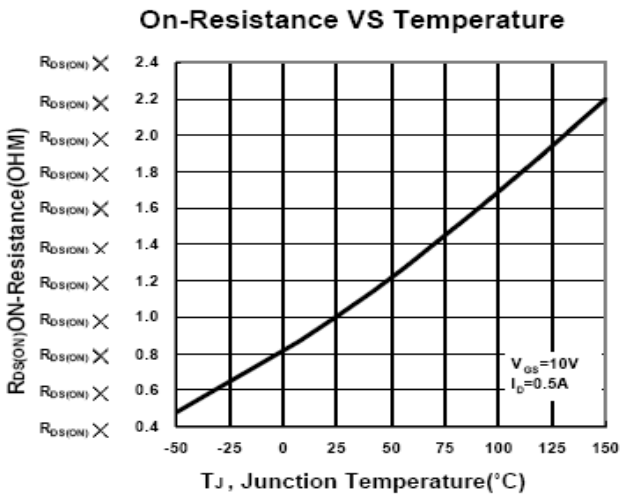
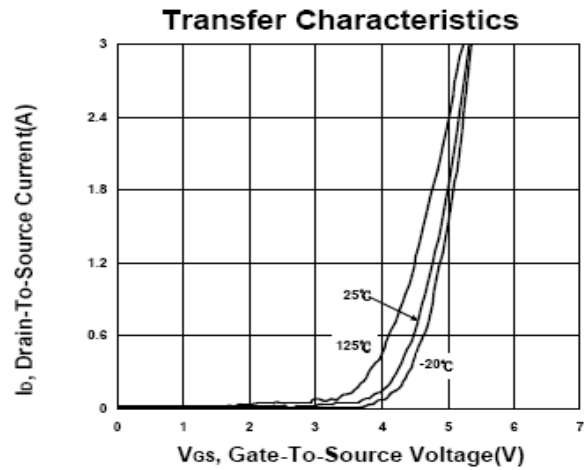
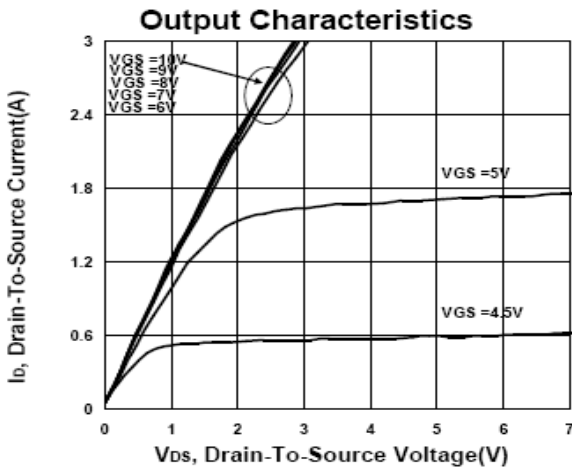
PARAMETER	SYMBOL	TEST CONDITIONS	LIMITS			UNIT
			MIN	TYP	MAX	
STATIC						
Drain-Source Breakdown Voltage	V _{(BR)DSS}	V _{GS} = 0V, I _D = 250μA	200			V
Gate Threshold Voltage	V _{GS(th)}	V _{DS} = V _{GS} , I _D = 250μA	2	3.2	4	V
Gate-Body Leakage	I _{GSS}	V _{DS} = 0V, V _{GS} = ±30V			±100	nA
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = 200V, V _{GS} = 0V			25	μA
		V _{DS} = 160V, V _{GS} = 0V, T _J = 55 °C			250	
Drain-Source On-State Resistance ¹	R _{DS(ON)}	V _{GS} = 10V, I _D = 0.5A		0.8	1.1	Ω
Forward Transconductance ¹	g _{fs}	V _{DS} = 5V, I _D = 0.5A		1.5		S
DYNAMIC						
Input Capacitance	C _{iss}	V _{GS} = 0V, V _{DS} = 25V, f = 1MHz		229		pF
Output Capacitance	C _{oss}			80		
Reverse Transfer Capacitance	C _{rss}			16		
Total Gate Charge ²	Q _g	V _{DS} = 160V I _D = 1A, V _{GS} = 10V		9		nC
Gate-Source Charge ²	Q _{gs}			1.2		
Gate-Drain Charge ²	Q _{gd}			5.5		
Turn-On Delay Time ²	t _{d(on)}	V _{DS} = 100V, I _D ≅ 1A, V _{GS} = 10V, R _{GS} = 25Ω		50		nS
Rise Time ²	t _r			300		
Turn-Off Delay Time ²	t _{d(off)}			80		
Fall Time ²	t _f			180		
SOURCE-DRAIN DIODE RATINGS AND CHARACTERISTICS (T_J = 25 °C)						
Continuous Current	I _S				1	A
Forward Voltage ¹	V _{SD}	I _F = 0.5A, V _{GS} = 0V			1.6	V
Reverse Recovery Time	t _{rr}	I _F = 1 A, di/dt = 100A / μS		119		nS
Reverse Recovery Charge	Q _{rr}				325	

¹Pulse test : Pulse Width ≤ 300 μsec, Duty Cycle ≤ 2%.

²Independent of operating temperature.

P0320AL

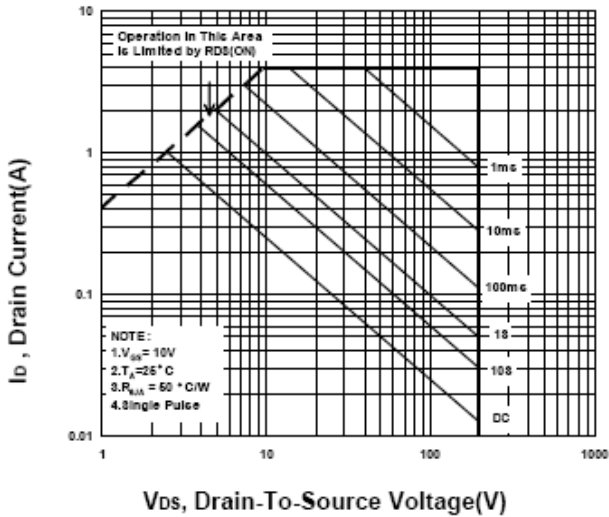
N-Channel Enhancement Mode MOSFET



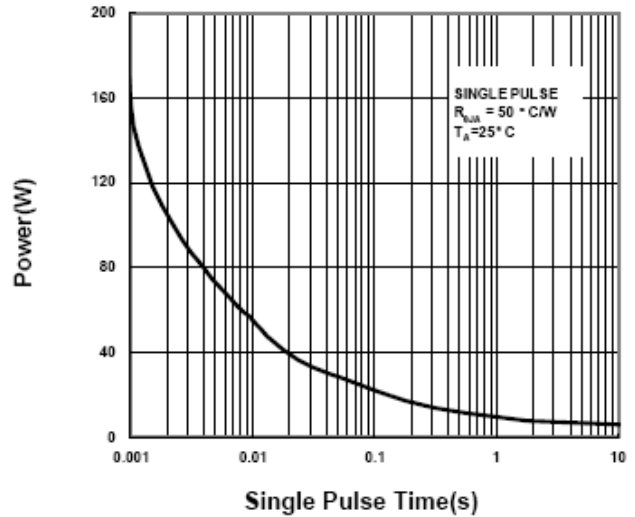
P0320AL

N-Channel Enhancement Mode MOSFET

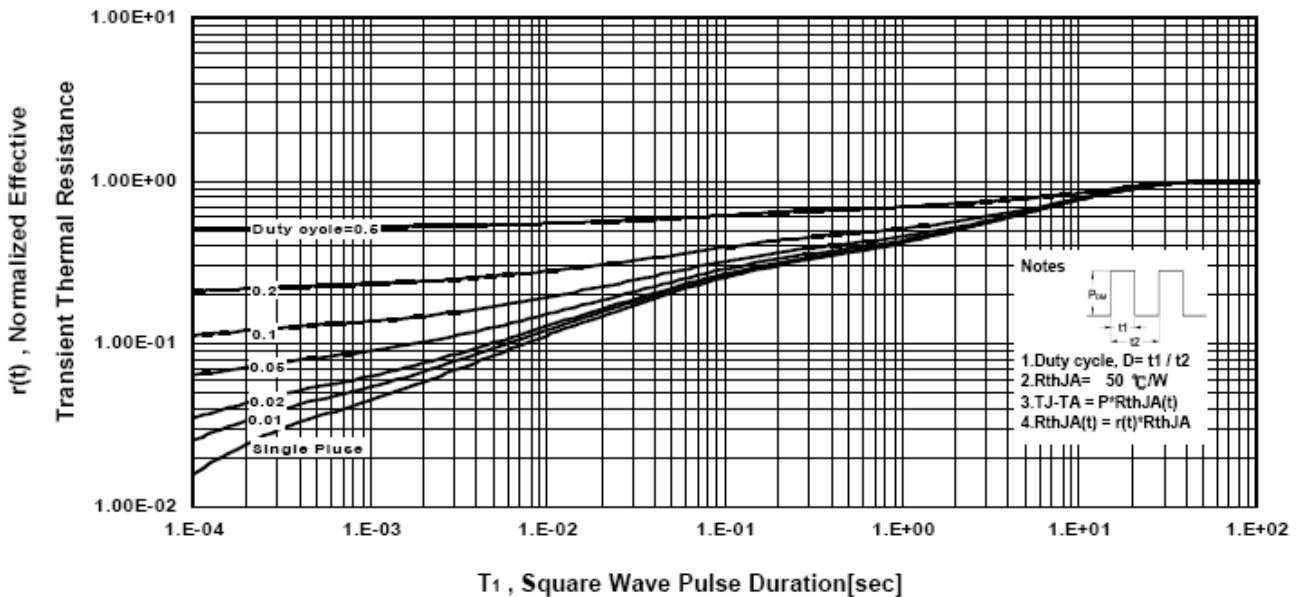
Safe Operating Area



Single Pulse Maximum Power Dissipation



Transient Thermal Response Curve



P0320AL
N-Channel Enhancement Mode MOSFET

SOT-223 MECHANICAL DATA

Dimension	mm			Dimension	mm		
	Min.	Typ.	Max.		Min.	Typ.	Max.
A	0.60	0.76	0.84	H	3.30	3.50	3.70
B	6.70	7.00	7.30	I	0.50	1.00	1.20
C	2.85	3.00	3.10	J	0.23	0.3	0.4
D	2.25	2.30	2.35	K	0°		10°
E	4.35	4.60	4.85	L	0	0.1	0.2
F	1.40	1.60	1.80	M			
G	6.30	6.50	6.80	N			

